PΊ	ro-1595 <b>RI</b>			2006	ET U.S. DEPARTMENT OF CO	
To the Honorable Commissioner of Patents at 103259111 original documents or copy thereof.						
1	Name of conveying party(ies):		2	Name and address	s of receiving party(ies):	PT0 16
	DAH-CHUEN HO EUGENE CHU YUH-HAW CHANG FEI-YUN CHEN MICHAEL WU ERIC CHAO			Taiwan Semicondu No. 8. Li-Hsin Rd. Science-Based Ind Hsin-Chu, Taiwan,	lustrial Park	112959 U.S.   11/45023
3	Nature of conveyance: ■ Assignment □ Merger			Additional name(s) & address(es) attached □ Yes   No		•
	☐ Security Agreement ☐ Change of Name					
	Other: Execution Date: May 22, 2006					
4	Application number(s) or patent number(s):					
	If this document is being filed together with a new application, the execution date of the application is:					
	A. Patent Application No(s).			B. Patent No(s)		
						· · · · · · · · · · · · · · · · · · ·
Additional numbers attached? □ Yes ⊠ No						
5	Name and address of party to whom correspondence concerning document should be mailed:		6	Total number of applications and patents involved:		
	RANDY W. TUNG		7	Total fee (37 CFR	3.41) \$40	.00
	Tung & Associates 838 W. Long Lake Road Suite 120			□ Enclosed	o charge credit card (w/fil	ing fee)
	Bloomfield Hills, Michigan 48302		8		eposit Account Number: Attach duplicate copy of this page if paying by deposit ccount)	
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9	Statement and signature.  To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.  6/9/06					
	Randy W. Tung Name of Person Signing Registration No. 31,311	Signature			Date	

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P.O. Box 1450

Alexandria, VA 22313-1450

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PATENT REEL: 017992 FRAME: 0557

## **ASSIGNMENT**

WHEREAS, we, DAH-CHUEN HO, EUGENE CHU, YUH-HAW CHANG, FEI-YUN CHEN, MICHAEL WU, and ERIC CHAO, have invented certain improvements in:

CONCAVE AND CONVEX MICROMIRRORS AND METHODS OF MAKING THE SAME

for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we, DAH-CHUEN HO, EUGENE CHU, YUH-HAW CHANG, FEI-YUN CHEN, MICHAEL WU, and ERIC CHAO, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the 22<sup>H</sup>/<sub>2</sub> day of May, 2006, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional, continuation or continuation-in-part

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application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

Dah-Chuen Ho
DAH-CHUEN HO

EUGENE CHU

**TUNG & ASSOCIATES** 838 W. Long Lake Road Suite 120

Bloomfield Hills, Michigan 48302

**RECORDED: 06/09/2006** 

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